



PRODUCT DATASHEET

- SMC High Power
- 3030 SMC 3.0t
 Series
- Red (625nm)

Release Date: 30 May 2022 Version: A1.1





NOR43S21

APPLICATIONS:

- Decorative Lighting
- Portable Lighting
- Outdoor Lighting
- Commercial Lighting
- Architectural Lighting
- Industrial Lighting

1

3030 SMC Series

ATTENTION

OBSERVE PRECAUTI FOR HANDLING



FEATURES:

- Package: TOP View SMC Package with Silicon Lens
- Forward Current: 70mA
- Forward Voltage (typ.): 2.3V
- Luminous Flux (typ.): 11lm@70mA
- Colour: Red
- Wavelength: 625nm
- Viewing angle: 30°
- Materials:
 - Die: AlInGaP
 - Resin: Silicon (Water Clear)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+100°C
- Grouping parameters:
 - Forward Voltage
 - Luminous Flux
 - Dominant Wavelength
- Soldering methods: IR Reflow
- Preconditioning: MSL2 according to J-STD020
- Packing: 12mm tape with Max.650pcs/reel, ø180mm (7")



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

| Parameter | Symbol | Ratings | Unit |
|---|------------------|----------|------|
| DC Forward Current | lf | 100 | mA |
| Reverse Voltage | VR | 5 | V |
| Reverse Current @5V | IR | 10 | μΑ |
| Junction Temperature | Tj | 125 | °C |
| Electrostatic Discharge (HBM: MIL-STD-883 C2) | ESD | 2000 | V |
| Operating Temperature | Topr | -40~+80 | °C |
| Storage Temperature | T _{STG} | -40~+100 | °C |
| Soldering Temperature | Tsol | 260 | °C |

Electrical & Optical Characteristics (Ta=25°C)

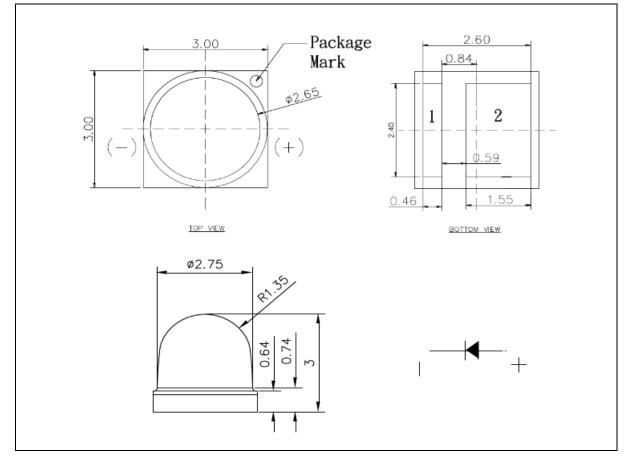
| Parameter | Symbol | Values | | | Unit | Test |
|---------------------|--------------------------|--------|------|------|------|----------------------|
| | | Min. | Тур. | Max. | Onit | Condition |
| Forward Voltage | V_{F} | 2.0 | | 2.6 | V | I _F =70mA |
| Luminous Flux | Φv | 8 | | 14 | lm | I⊧=70mA |
| Dominant Wavelength | λ_{D} | 620 | | 630 | nm | I⊧=70mA |
| Viewing Angle | 2θ _{1/2} | | 30 | | deg | I⊧=70mA |

1. Luminous flux ($\Phi_V)$ ±7%, Forward Voltage (V_F) ±0.1V, Viewing angle(2\theta_{1/2}) ±10°



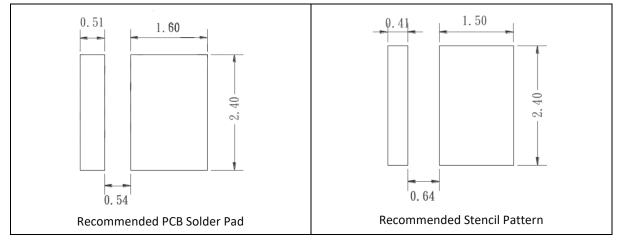
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- **2.** Tolerance ± 0.12 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Code Min. Max. Unit V2022 2.0 2.2 V V2224 2.2 2.4 V V2426 2.4 2.6 V

Forward Voltage Classifications (I_F = 70mA):

Luminous Flux Classifications (I_F = 70mA):

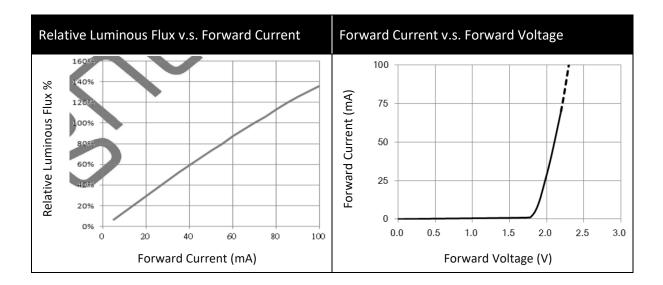
| Code | Min. | Max. | Unit | |
|------|------|------|------|--|
| B09 | 8 | 9 | | |
| B10 | 9 | 10 | - Im | |
| B11 | 10 | 12 | | |
| B12 | 12 | 14 | | |

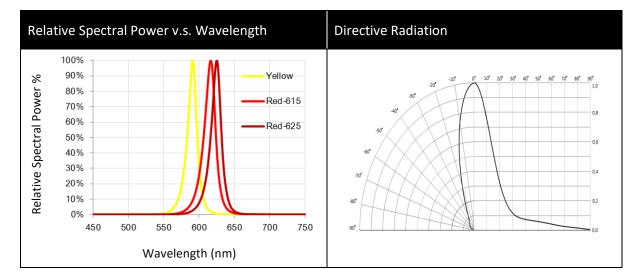
Dominant Wavelength Classifications (I_F = 70mA):

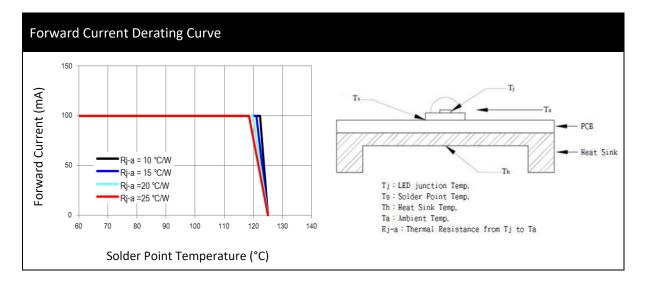
| Code | Min. | Max. | Unit | |
|------|------|------|------|--|
| R620 | 620 | 625 | | |
| R625 | 625 | 630 | nm | |



ELECTRO-OPTICAL CHARACTERISTICS:



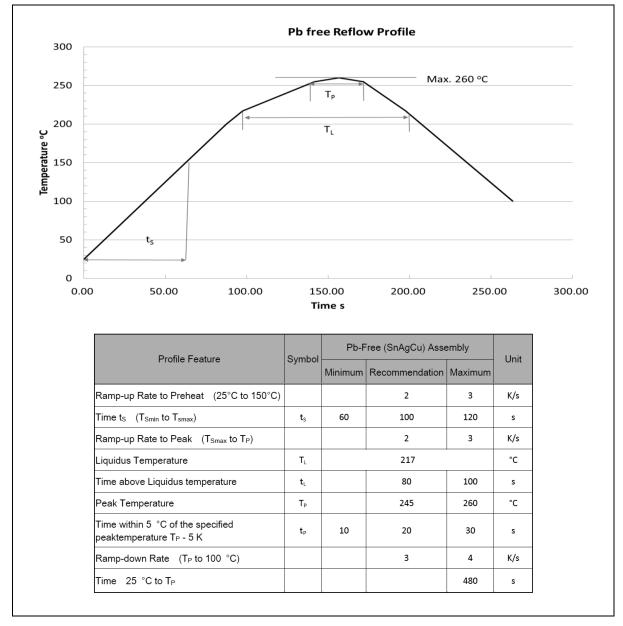






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



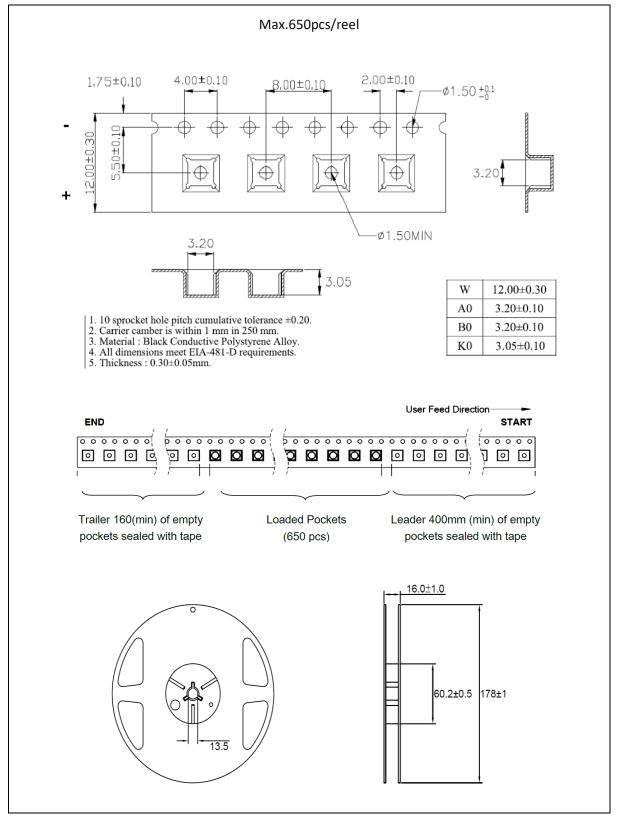
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. The recommended soldering temperature is 245°C. Maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



7

PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

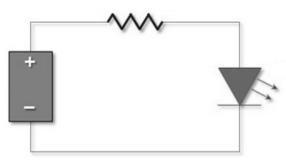
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

| Version | Date | Summary of Revision |
|---------|------------|---------------------|
| A1.0 | 06/04/2018 | Datasheet set-up. |
| A1.1 | 30/05/2022 | Revised code. |